

Power Bridge Rectifiers

DBI 25

Features

- Isolated metal case with in-line wire leads
- Ideal for printed circuit boards
- Allow easy heatsink mounting
- Solder temperature: 260°C max. (max. 5 s)
- Blocking voltage up to 1600 V
- High surge current
- UL recognized, file no. E63532
- Lead-Free tinned terminals
- Standard packing: 54 pieces box

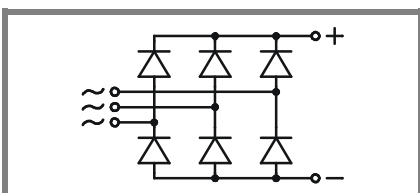
Typical Applications*

- 3 phase rectifier for power supplies
- Input rectifier for variable frequency drives
- Rectifier for DC motor field supplies
- Battery charger rectifiers
- Recommended snubber network: RC: 50 Ω, 0.1 μF (P_R = 1 W)

- 1) Mounted on a 50 x 75 mm p.c.b.
- 2) Mounted on a painted metal sheet of min. 250 x 250 x 1 mm
- 3) Recommended V_{VRMS} values:
V_{VRMS} = V_{RRM} / 2,83

V _{RSM} , V _{RRM} V	V _{VRMS} V	I _D = 25 A (T _c = 32 °C) Types	C _{max} μF	R _{min} Ω
400	280	DBI 25-04		0,3
800	560	DBI 25-08		0,7
1200	800	DBI 25-12		1
1600	1000	DBI 25-16		1,5
1800	1250	DBI 25-18		1,8

Symbol	Conditions	Values	Units
I _D	T _a = 46 °C, P1/120, natural cooling T _a = 46 °C, chassis ²⁾	17 11	A A
I _{DCL}	T _a = 46 °C, P1/120, natural cooling T _a = 46 °C, chassis ²⁾ T _a = 45 °C, isolated ¹⁾	17 11 2,9	A A A
I _{FSM}	T _{vi} = 25 °C, 10 ms T _{vi} = 150 °C, 10 ms	370 310	A A
i ² t	T _{vi} = 25 °C, 8,3 ... 10 ms T _{vi} = 150 °C, 8,3 ... 10 ms	680 480	A ² s A ² s
V _F V _(TO) r _T I _{RD} I _{RD} t _{rr} f _G	T _{vi} = 25°C, I _F = 150 A T _{vi} = 150°C T _{vi} = 150°C T _{vi} = 25°C, V _{RD} = V _{RRM} T _{vi} = 150°C, V _{RD} = V _{RRM} T _{vi} = 25°C	max. 2,2 max. 0,85 max. 9 50 5 10 2000	V V mΩ μA mA μs Hz
R _{th(j-a)} R _{th(i-c)} R _{th(c-s)} T _{vi} T _{stg}	isolated ¹⁾ chassis ²⁾ total (from chips to bridge back side) total	21 5 2,2 0,15	K/W K/W K/W °C °C
V _{isol} M _s M _t a w	a.c. 50...60 Hz; r.m.s.; 1s / 1 min. torque for mounting (M4 screw)	3000 / 2500 2 ± 15%	V~ Nm Nm m/s ² g
Fu			A
Case	40 x 20 x 10 mm plus leads = 20 mm	DBI	



DB (B6U)

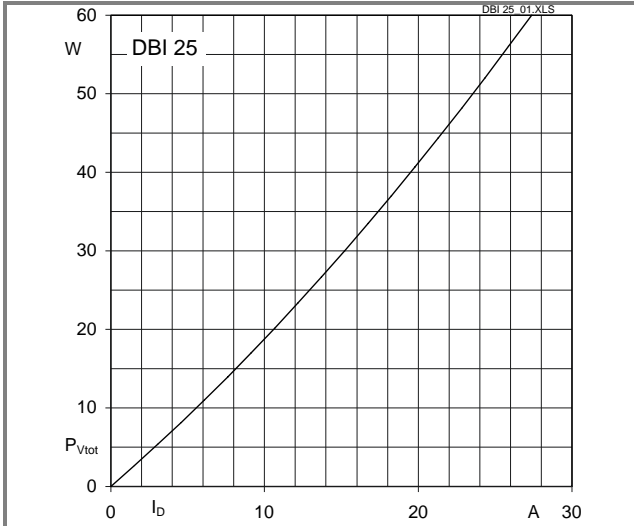


Fig. 3L Power dissipation vs. output current

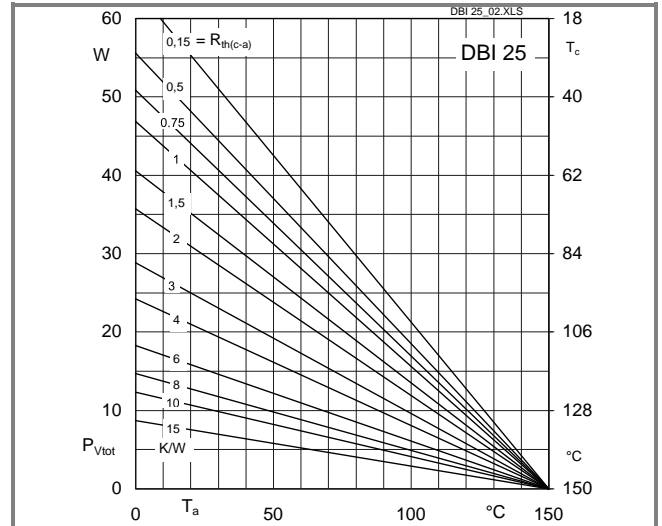


Fig. 3R Power dissipation vs. case temperature

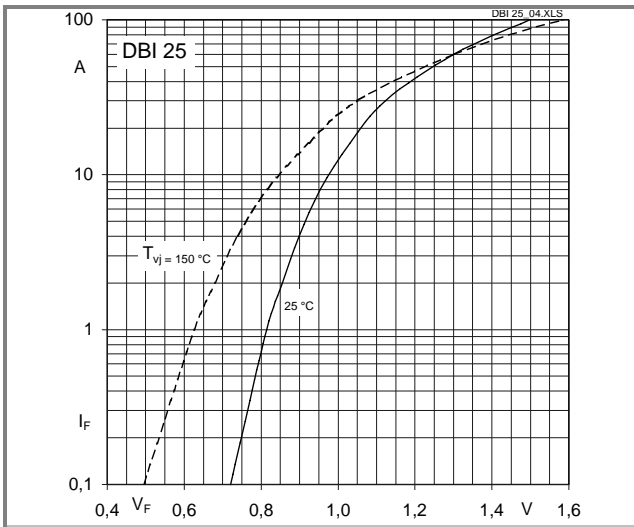
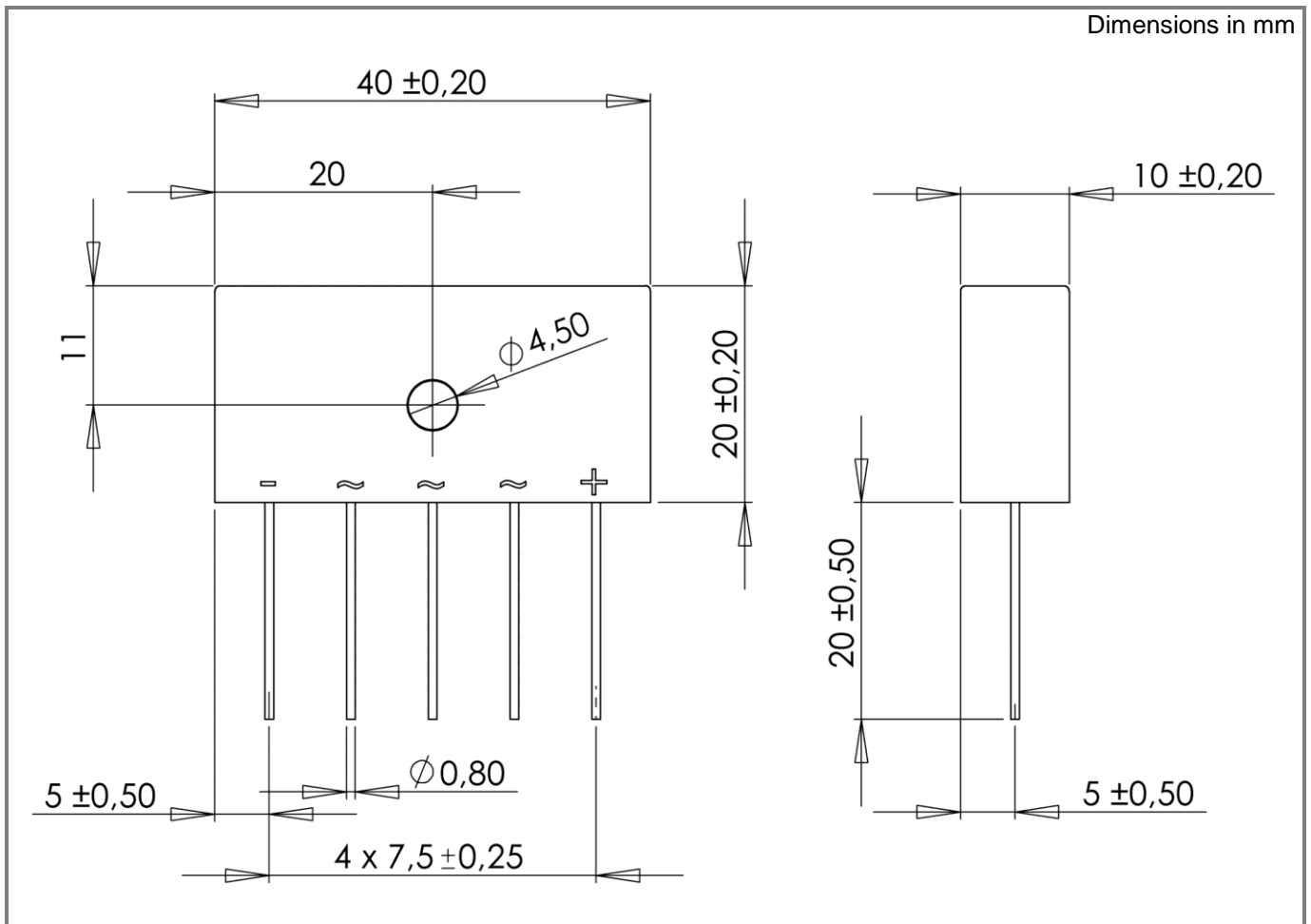


Fig. 9 Forward characteristics of a diode arm (typical)



Case DBI

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